

SKM1000GAL17R8



SEMITRANS® 10

IGBT R8 Modules

SKM1000GAL17R8

Features*

- Symmetrical current sharing
- Low-inductive module design
- High mechanical robustness
- UL recognized, file no. E63532

Typical Applications

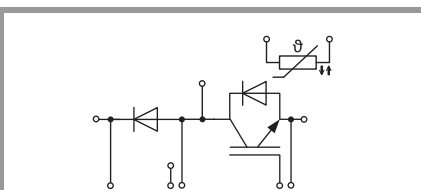
- Brake chopper
- Windturbines

Remarks

Recommended $T_{jop} = -40 \dots +150^{\circ}\text{C}$

| Absolute Maximum Ratings | | | | |
|---------------------------|--|-----------------------------|-------------|--------------------|
| Symbol | Conditions | | Values | Unit |
| IGBT | | | | |
| V_{CES} | $T_j = 25^{\circ}\text{C}$ | | 1700 | V |
| I_C | $T_j = 175^{\circ}\text{C}$ | $T_c = 25^{\circ}\text{C}$ | 1574 | A |
| | | $T_c = 100^{\circ}\text{C}$ | 1027 | A |
| I_{Cnom} | | | 1000 | A |
| I_{CRM} | | | 2000 | A |
| V_{GES} | | | -20 ... 20 | V |
| t_{psc} | $V_{CC} = 1200\text{ V}$ | $T_j = 150^{\circ}\text{C}$ | 10 | μs |
| | $V_{GE} \leq 15\text{ V}$ | | | |
| | $V_{CES} \leq 1700\text{ V}$ | | | |
| T_j | | | -40 ... 175 | $^{\circ}\text{C}$ |
| Inverse diode | | | | |
| V_{RRM} | $T_j = 25^{\circ}\text{C}$ | | 1700 | V |
| I_F | $T_j = 175^{\circ}\text{C}$ | $T_c = 25^{\circ}\text{C}$ | 1449 | A |
| | | $T_c = 100^{\circ}\text{C}$ | 905 | A |
| I_{FRM} | | | 2000 | A |
| I_{FSM} | $t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 25^{\circ}\text{C}$ | | 6240 | A |
| T_j | | | -40 ... 175 | $^{\circ}\text{C}$ |
| Freewheeling diode | | | | |
| V_{RRM} | $T_j = 25^{\circ}\text{C}$ | | 1700 | V |
| I_F | $T_j = 175^{\circ}\text{C}$ | $T_c = 25^{\circ}\text{C}$ | 1449 | A |
| | | $T_c = 100^{\circ}\text{C}$ | 905 | A |
| I_{FRM} | | | 2000 | A |
| I_{FSM} | $t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 25^{\circ}\text{C}$ | | 6240 | A |
| T_j | | | -40 ... 175 | $^{\circ}\text{C}$ |
| Module | | | | |
| T_{stg} | | | -40 ... 150 | $^{\circ}\text{C}$ |
| V_{isol} | AC sinus 50 Hz, $t = 1\text{ min}$ | | 4000 | V |

| Characteristics | | | | | | |
|-----------------|---|-----------------------------|------|------|------|------------------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| IGBT | | | | | | |
| $V_{CE(sat)}$ | $I_C = 1000\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel | $T_j = 25^{\circ}\text{C}$ | 1.66 | 1.99 | | V |
| | | $T_j = 150^{\circ}\text{C}$ | 2.01 | 2.33 | | V |
| V_{CE0} | chipelevel | $T_j = 25^{\circ}\text{C}$ | 1.06 | 1.12 | | V |
| | | $T_j = 150^{\circ}\text{C}$ | 0.95 | 1.05 | | V |
| r_{CE} | $V_{GE} = 15\text{ V}$ chipelevel | $T_j = 25^{\circ}\text{C}$ | 0.60 | 0.87 | | $\text{m}\Omega$ |
| | | $T_j = 150^{\circ}\text{C}$ | 1.06 | 1.28 | | $\text{m}\Omega$ |
| $V_{GE(th)}$ | $V_{CE} = 10\text{ V}, I_C = 36\text{ mA}$ | | 5 | 5.8 | 6.5 | V |
| I_{CES} | $V_{GE} = 0\text{ V}, V_{CE} = 1700\text{ V}, T_j = 25^{\circ}\text{C}$ | | | | 6.0 | mA |
| C_{ies} | $V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$ | $f = 1\text{ MHz}$ | 90.0 | | | nF |
| C_{oes} | | $f = 1\text{ MHz}$ | 3.00 | | | nF |
| C_{res} | | $f = 1\text{ MHz}$ | 0.24 | | | nF |
| Q_G | $V_{GE} = -15\text{ V} \dots +15\text{ V}$ | | 5640 | | | nC |
| R_{Gint} | $T_j = 25^{\circ}\text{C}$ | | 1.7 | | | Ω |



GAL



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Features*

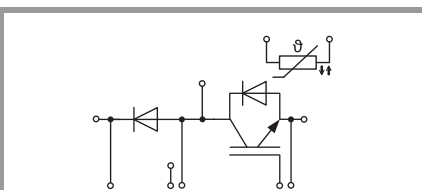
- Symmetrical current sharing
- Low-inductive module design
- High mechanical robustness
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Typical Applications

- Brake chopper
- Windturbines

Remarks

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| Characteristics | | | | | |
|---------------------------|---|---------------------------|--------|-------|---------------|
| Symbol | Conditions | min. | typ. | max. | Unit |
| IGBT | | | | | |
| $t_{d(on)}$ | $V_{CC} = 900\text{ V}$ | $T_j = 150^\circ\text{C}$ | 450 | | ns |
| t_r | $I_C = 1000\text{ A}$ | $T_j = 150^\circ\text{C}$ | 95 | | ns |
| E_{on} | $V_{GE} = +15/-15\text{ V}$ | $T_j = 150^\circ\text{C}$ | 420 | | mJ |
| $t_{d(off)}$ | $R_{G\ on} = 0.7\ \Omega$ | $T_j = 150^\circ\text{C}$ | 610 | | ns |
| t_f | $R_{G\ off} = 0.7\ \Omega$ | $T_j = 150^\circ\text{C}$ | 185 | | ns |
| E_{off} | $di/dt_{on} = 9.6\text{ kA}/\mu\text{s}$ $di/dt_{off} = 5.35\text{ kA}/\mu\text{s}$ $dv/dt = 3900\text{ V}/\mu\text{s}$ $L_s = 36\text{ nH}$ | $T_j = 150^\circ\text{C}$ | 330 | | mJ |
| $R_{th(j-c)}$ | per IGBT | | | 0.03 | K/W |
| $R_{th(c-s)}$ | per IGBT ($\lambda_{grease}=0.81\text{ W}/(\text{m}^*\text{K})$) | | 0.016 | | K/W |
| Inverse diode | | | | | |
| $V_F = V_{EC}$ | $I_F = 1000\text{ A}$ | $T_j = 25^\circ\text{C}$ | 1.78 | 2.12 | V |
| | $V_{GE} = 0\text{ V}$ chipelevel | $T_j = 150^\circ\text{C}$ | 1.81 | 2.14 | V |
| V_{F0} | chipelevel | $T_j = 25^\circ\text{C}$ | 1.32 | 1.56 | V |
| | | $T_j = 150^\circ\text{C}$ | 1.08 | 1.22 | V |
| r_F | chipelevel | $T_j = 25^\circ\text{C}$ | 0.46 | 0.56 | m Ω |
| | | $T_j = 150^\circ\text{C}$ | 0.73 | 0.92 | m Ω |
| I_{RRM} | $I_F = 1000\text{ A}$ | $T_j = 150^\circ\text{C}$ | 800 | | A |
| Q_{rr} | $V_{GE} = -15\text{ V}$ | $T_j = 150^\circ\text{C}$ | 320 | | μC |
| E_{rr} | $di/dt_{off} = 9.1\text{ kA}/\mu\text{s}$ $V_R = 900\text{ V}$ | $T_j = 150^\circ\text{C}$ | 160 | | mJ |
| $R_{th(j-c)}$ | per diode | | | 0.042 | K/W |
| $R_{th(c-s)}$ | per diode ($\lambda_{grease}=0.81\text{ W}/(\text{m}^*\text{K})$) | | 0.017 | | K/W |
| Freewheeling diode | | | | | |
| $V_F = V_{EC}$ | $I_F = 1000\text{ A}$ | $T_j = 25^\circ\text{C}$ | 1.78 | 2.12 | V |
| | $V_{GE} = 0\text{ V}$ level = chipelevel | $T_j = 150^\circ\text{C}$ | 1.81 | 2.14 | V |
| V_{F0} | chipelevel | $T_j = 25^\circ\text{C}$ | 1.32 | 1.56 | V |
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| $R_{th(j-c)}$ | per diode | | | 0.042 | K/W |
| $R_{th(c-s)}$ | per diode ($\lambda_{grease}=0.81\text{ W}/(\text{m}^*\text{K})$) | | 0.017 | | K/W |
| Module | | | | | |
| L_{CE} | | | 10 | | nH |
| $R_{CC'+EE'}$ | measured per switch, $T_C = 25^\circ\text{C}$ | | 0.2 | | m Ω |
| $R_{th(c-s)1}$ | calculated without thermal coupling ($\lambda_{grease}=0.81\text{ W}/(\text{m}^*\text{K})$) | | 0.0041 | | K/W |
| $R_{th(c-s)2}$ | including thermal coupling, T_s underneath module ($\lambda_{grease}=0.81\text{ W}/(\text{m}^*\text{K})$) | | 0.007 | | K/W |
| M_s | to heat sink M5 | 4 | | 6 | Nm |
| M_t | | | | | |
| | to terminals M8 | 8 | | 10 | Nm |
| | to terminals M4 | 1.8 | | 2.1 | Nm |
| w | | | | 1250 | g |

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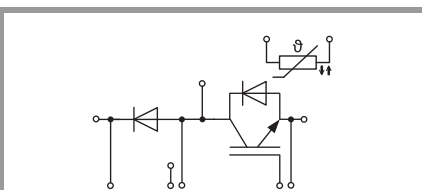
- Brake chopper
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Remarks

Recommended $T_{jop} = -40 \dots +150^{\circ}\text{C}$

Characteristics

| Symbol | Conditions | min. | typ. | max. | Unit |
|---------------------------|--|------|---------------------|------|----------|
| Temperature Sensor | | | | | |
| R_{100} | $T_c=100^{\circ}\text{C}$ ($R_{25}=5 \text{ k}\Omega$) | | $493 \pm 5\%$ | | Ω |
| $B_{100/125}$ | $R(T)=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$; $T[\text{K}]$; | | 3550 $\pm 2\%$ | | K |



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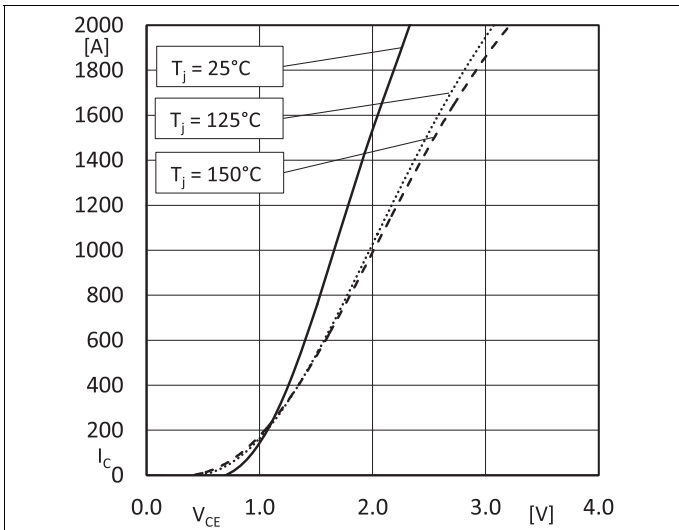


Fig. 1: Output characteristics IGBT (typical); $I_C = f(V_{CE})$; $V_{GE} = 15V$; (chipelevel)

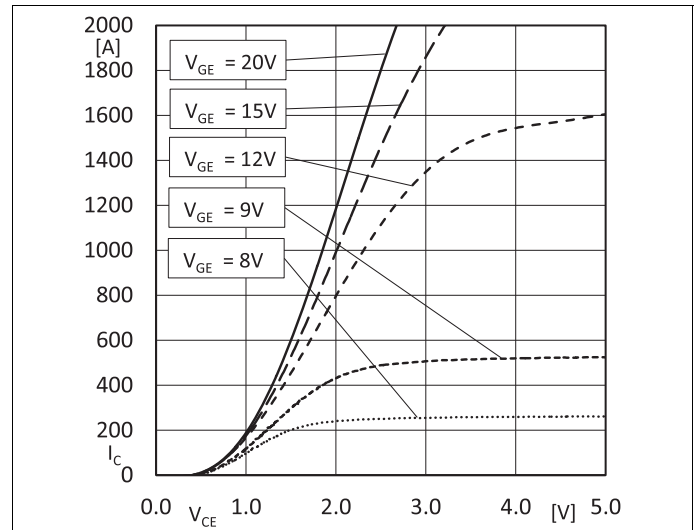


Fig. 2: Output characteristics IGBT (typical); $I_C = f(V_{CE})$; $T_j = 150^\circ C$; (chipelevel)

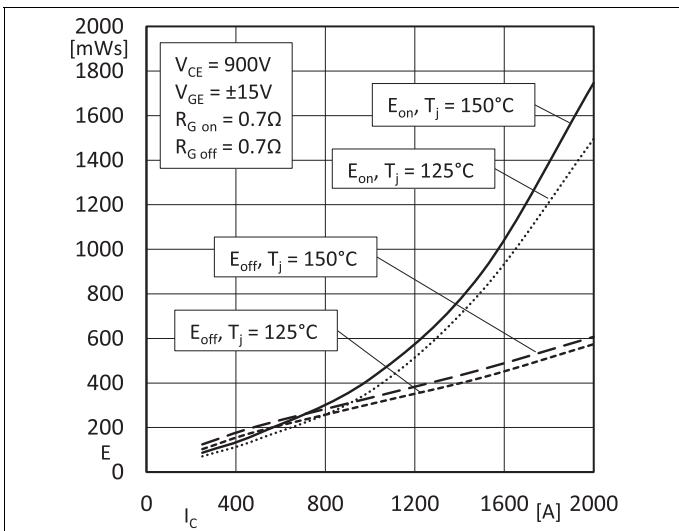


Fig. 3: Switching losses IGBT (typical); $E=f(I_C)$

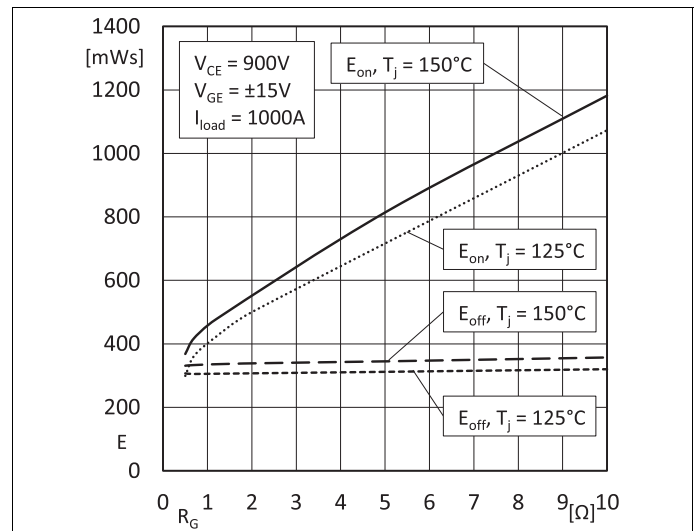


Fig. 4: Switching losses IGBT (typical); $E=f(R_G)$

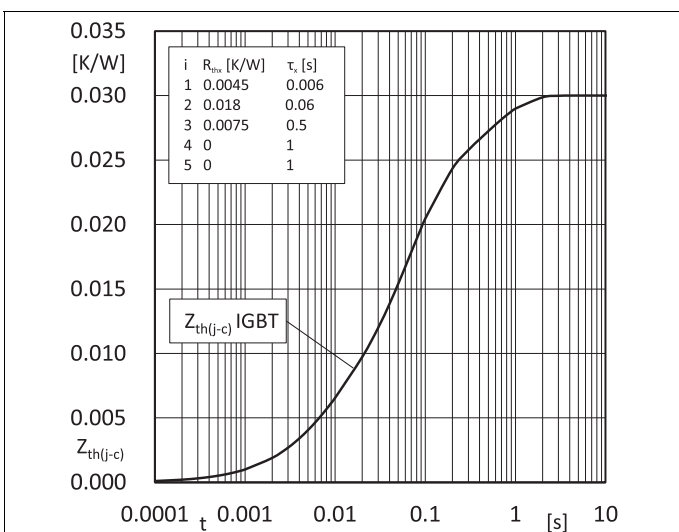


Fig. 5: Transient thermal impedance IGBT

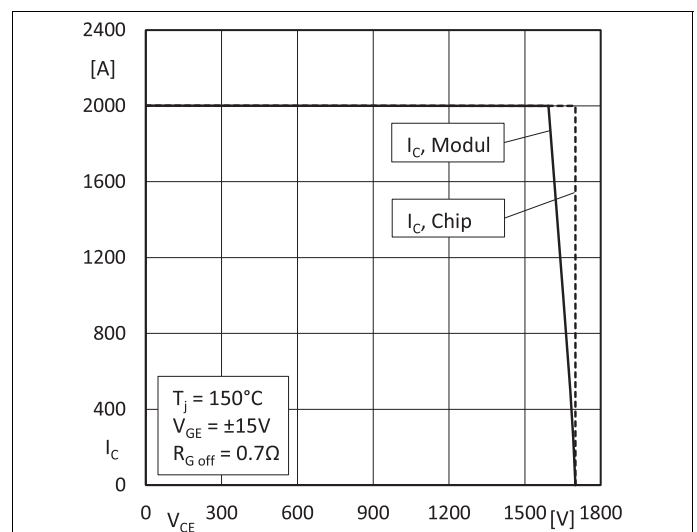


Fig. 6: RBSOA IGBT

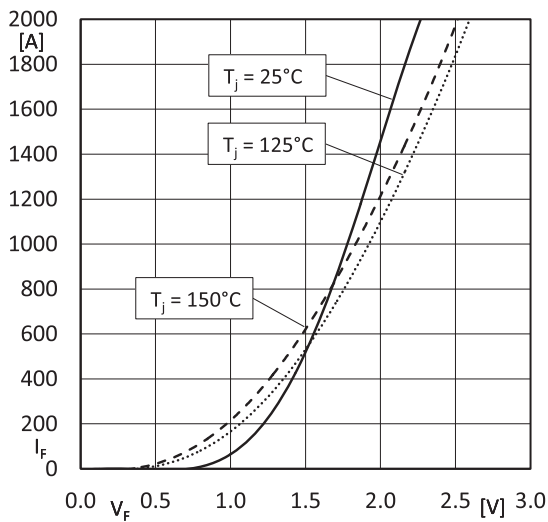


Fig. 7: Forward charact. Diode (typical); $I_F = f(V_F)$; (chipllevel)

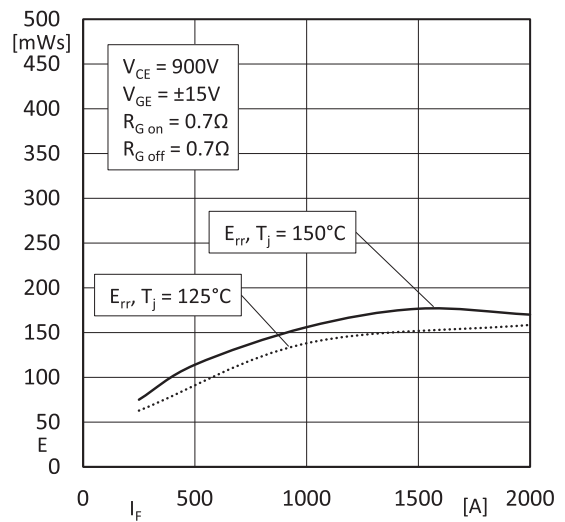


Fig. 8: Switching losses Diode (typical); $E = f(I_F)$

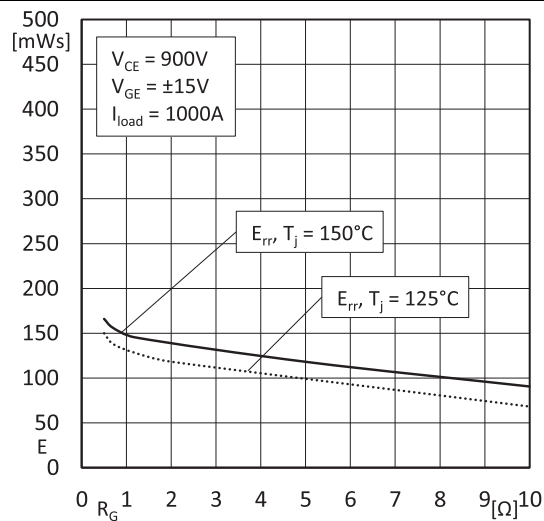


Fig. 9: Switching losses Diode (typical); $E = f(R_G)$

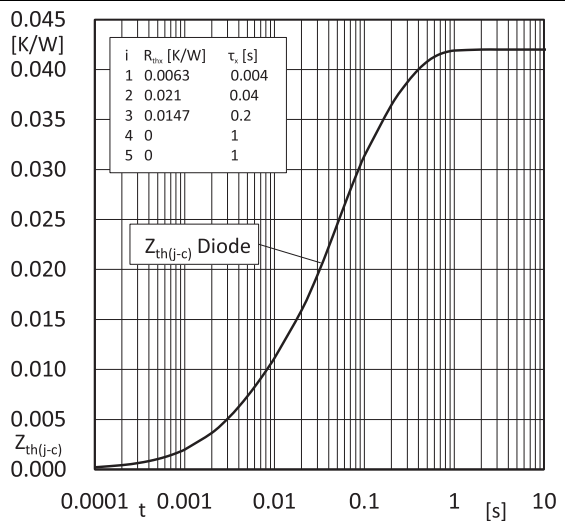


Fig. 10: Transient thermal impedance Diode

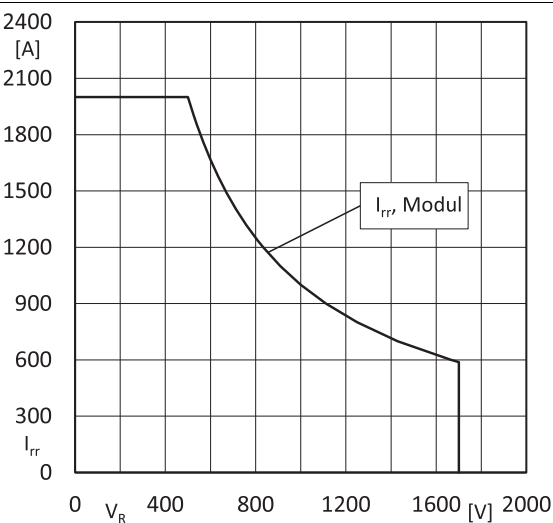


Fig. 11: RBSOA Diode

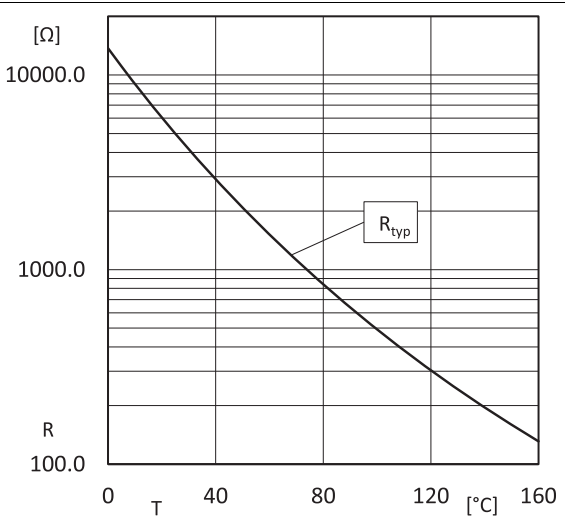


Fig. 12: NTC characteristics (typical)

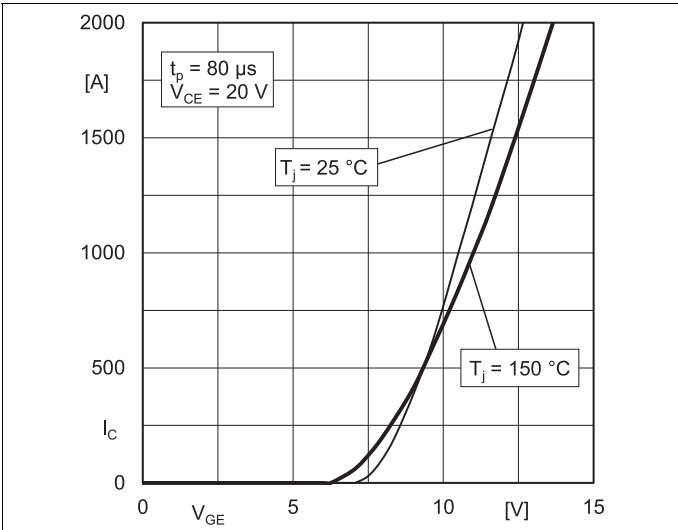


Fig. 13: Typ. transfer characteristic

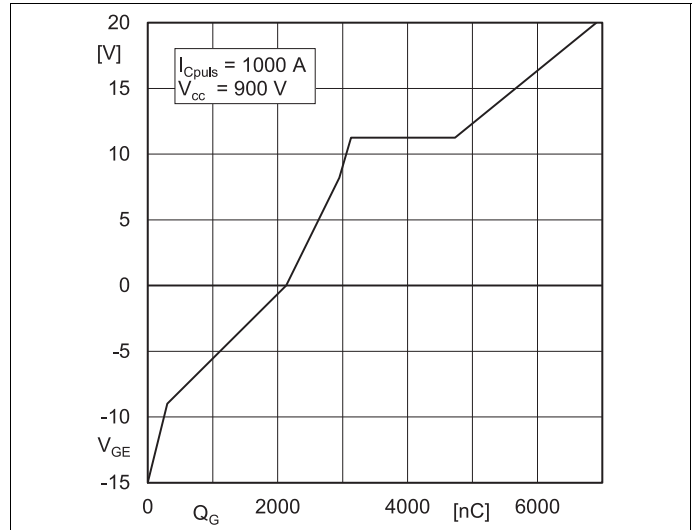
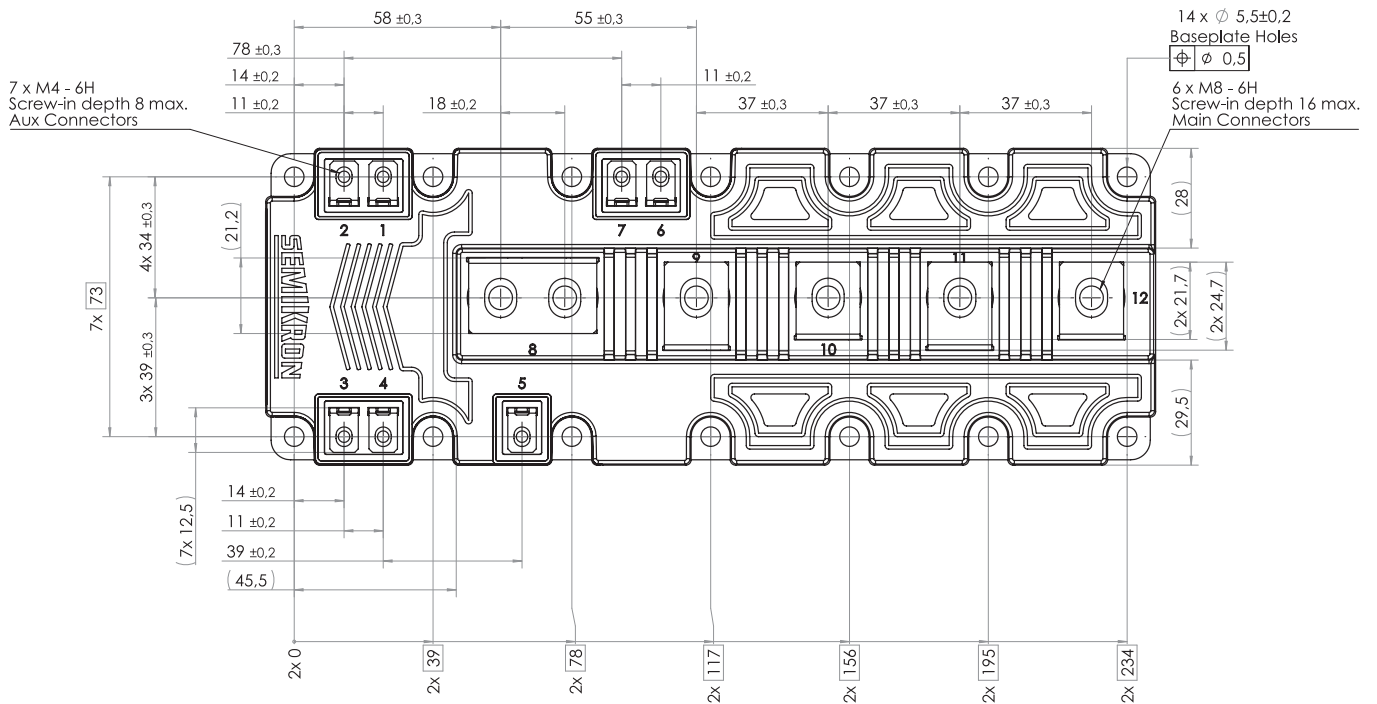
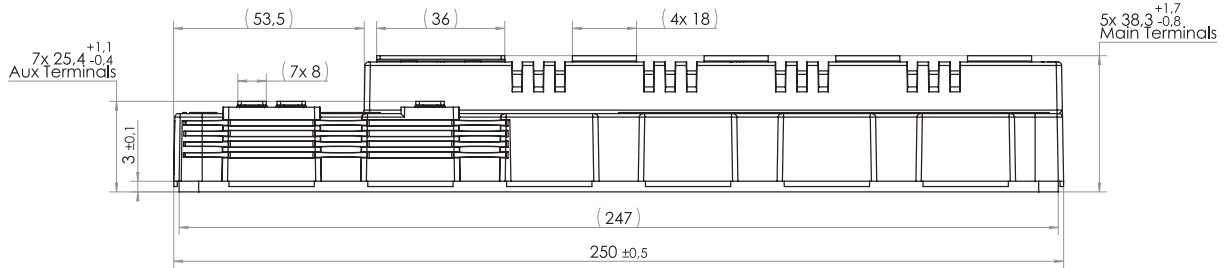
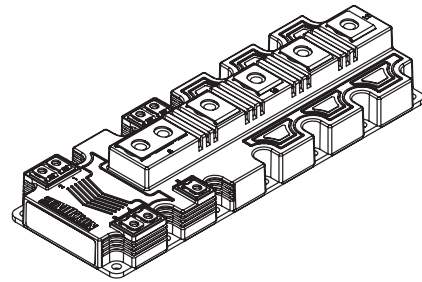
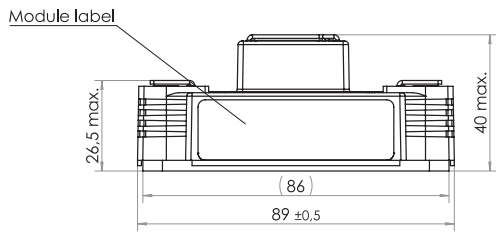


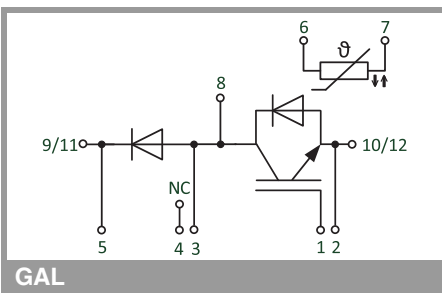
Fig. 14: Typ. gate charge characteristic

SKM1000GAL17R8



- Dimensions in mm
- General tolerances $\pm 0.5\text{mm}$

SEMITRANS 10



This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

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